



PolySwitch Resettable Devices

Telecommunications & Networking Devices

PolySwitch devices for telecommunication and networking applications were initially designed over ten years ago to meet the growing demand for resettable overcurrent protection. These product families help provide protection against power cross and power induction surge as defined in ITU, Telcordia, and UL. Available in chip, surface-mount, and radial-leaded configurations, PolySwitch devices help improve the reliability of customer premise and network equipment world wide.



Benefits

- Many product choices give engineers more design flexibility
- Compatible with high volume electronics assembly
- Assist in meeting regulatory requirements
- Improved line balance
- Applicable for legacy POTS and modern digital communications equipment

Features

- RoHS compliant
- Resettable overcurrent protection
- Surface-mount, radial-leaded, and chip form factors
- Fast time-to-trip
- Agency recognition: UL, CSA, TÜV
- Resistance sorted and matched devices available
- Low parasitic capacitance/flat impedance with frequency

Applications

- | | | |
|----------------------|---------------------------------|----------------------------------|
| • Modems | • PBX systems | • Powered ethernet systems |
| • Phone sets | • MDF modules | • VoIP (Voice over IP equipment) |
| • Fax machines | • Analog and digital line cards | • LAN, WAN equipment |
| • Phone wall outlets | • T1/E1 equipment | • Customer premise equipment |
| • Alarm systems | • xDSL modems and splitters | • Access network hardware |

Protection Application Guide for Telecommunications and Networking Devices*

To use this guide, follow the steps below:

1. Select your equipment type from the guide below.
2. Select the type of protection depending on the agency and regional specifications in the second column.
3. Select the form factor for your application.
4. Use the Agency Specification/ PolySwitch Device Selection Guide on the next page to select a specific part number for each application based on the agency requirements.
5. Parts with fast time-to-trip or low resistance are available. Please consult a Raychem Circuit Protection product representative.

Application	Region/ Specification	Overcurrent Protection			Overvoltage Protection
		Form Factor			SiBar Thyristor Surge Protectors†
		Radial-leaded	Surface-mount	Chip	
Customer Premises equipment	North America	TRF600-150	TS600-170F		TVBxxx(N/R)SA-L,
IT equipment	TIA-968-A (formerly FCC Part 68), UL 60950		TS600-200F		TVBxxx(N/M)SB-L, or TVAxix(N/R)SA-L
Analog modems, V.90 modems, ISDN modems, xDSL modems, ADSL splitters, phone sets, fax machines, answering machines, caller ID, internet appliances, PBX systems, POS terminals, wall plugs	Europe/Asia/ South America	TRF250-120	TS250-130F		TVBxxx(N/R)SA-L
	ITU K.21	TRF250-120T	TSV250-130F		TVAxix(N/R)SA-L
		TRF250-145			
		TRF250-180			
		TRF250-183			
Access network equipment (†)	North America	TRF600-160	TS600-170F		TVBxxx(N/M/R)SC-L
Remote terminals, line repeaters, multiplexers, cross-connects, WAN equipment	Telcordia GR-1089		TS600-200F TSM600-250F TSM600-400F†† FT600-1250**		
	Europe/Asia/ South America	TRF250-120	TS250-130F		TVBxxx(N/R)SA-L
	ITU K.45	TRF250-145	TSV250-130F		TVAxix(N/R)SA-L
		TRF250-120T			
		TRF250-180			
		TRF250-183			
Central office switching equipment (†)	North America	TRF600-160	TSM600-250F		TVBxxx(N/M/R)SC-L
Analog/POTS linecards, ISDN linecards, xDSL modems, ADSL/VDSL splitters, T1/E1 linecards, multiplexers, CSU/DSU, servers	Telcordia GR-1089		TSM600-170F TSM600-200F FT600-1250** TSM600-400F††		
	Europe/Asia/ South America	TRF250-120	TS250-130F		TVBxxx(N/R)SA-L
	ITU K.20	TRF250-145	TSV250-130F		TVAxix(N/R)SA-L
		TRF250-120T			
		TRF250-180			
		TRF250-183		TCF250-180	
Primary protection modules (†)	North America	TRF250-180			N/A
MDF modules, Network Interface Devices (NID)	Telcordia GR-974				
	Europe/Asia/ South America	TRF250-120T	TS250-130F	TCF250-120T	TVBxxx(N/M/R)Sx-L
	ITU K.20	TRF250-145T	TSV250-130F	TCF250-145T	
		TRF250-145		TCF250-180	
Short-haul/intrabuilding communications equipment (†)	North America	TRF250-120	TS250-130F		TVBxxx(N/R)SA-L
LAN equipment, VoIP cards, cable telephony NIUs, wireless local loop handsets	Telcordia GR-1089 intrabuilding	TRF250-145	TSL250-080F		TVAxix(N/R)SA-L
		TRF250-120T	TSV250-130F		
	Europe/Asia/ South America	TRF250-120	TS250-130F		TVBxxx(N/R)SA-L
	ITU K.21	TRF250-145	TSV250-130F		TVAxix(N/R)SA-L
		TRF250-180			
		TRF250-183			
LAN intrabuilding power cross protection			TSL250-080F		TVBxxx(N/R)SA-L
LAN equipment, VoIP cards, IP phones					TVAxix(N/R)SA-L
IEEE 802.3 Power over LAN protection			decaSMDC050F/60-2‡‡		N/A
Powered ethernet switches and terminals, IP phones, wireless LAN base stations, microcellular base stations, VoIP cards					
Cable telephony powering system		BBRF550***			N/A
Power passing taps		BBRF750***			

* This list is not exhaustive. Tyco Electronics welcomes our customers' input for additional application ideas for PolySwitch resettable devices.

† For improved line balance in these applications, resistance-matched parts are recommended.

‡ For more information on Raychem Circuit Protection SiBar thyristor surge protectors, refer to the SiBar product section on page 37.

** FT600-1250 are surface mount telecom fuse devices. FT600-0500 and FT600-2000 reference also available. See FT600 section on page 100.

†† Helps meet GR-1089 issue 3. Consult Raychem Circuit Protection for meeting GR-1089 issue 4.

‡‡ For details on decaSMDC050F/60-2, see surface-mount devices section on page 109.

*** For details on BBRF series, see radial-leaded devices section on page 125.

Agency Specification/PolySwitch Selection Guide for Telecommunications and Networking Devices

Use the guide below to select the PolySwitch devices which are typically used in your application. The following pages contain the specifications for the part numbers recommended below. PolySwitch devices assist telecommunication equipment in meeting the applicable protection requirements of these industry specifications. Refer to individual agency specifications for test procedures and circuit schematics. Users should independently evaluate the suitability of, and test each product for their application.

Family	Product*	Lightning	Power Cross	
TCF250	TCF250-145T	ITU K.20/21/45 – 4.0kV 10/700µs†	ITU K.20/21/45 – 230V _{AC} , 10Ω	
	TCF250-180		ITU K.20/21/45 – 600V _{AC} , 600Ω	
	TCF250-120T			
TRF250	TRF250-080U	ITU K.20 – 1.0kV 10/700µs	ITU K.20 – 230V _{AC} , 10Ω ITU K.20 – 600V _{AC} , 600Ω	
	TRF250-110U	ITU K.20/21/45 – 1.5kV 10/700µs	ITU K.20/21/45 – 230V _{AC} , 10Ω	
	TRF250-120	ITU K.20/21/45 – 4.0kV 10/700µs†	ITU K.20/21/45 – 600V _{AC} , 600Ω	
	TRF250-120T			
	TRF250-120U			
	TRF250-120UT			
	TRF250-145			
	TRF250-145U			
	TRF250-180			
	TRF250-180US			
	TRF250-183			
	TS250/TSV250	TSV250-130F	ITU K.20/21/45 – 1.5kV 10/700µs	ITU K.20/21/45 – 230V _{AC} , 10Ω
		TS250-130F	ITU K.20/21/45 – 4.0kV 10/700µs†	ITU K.20/21/45 – 600V _{AC} , 600Ω
TSL250	TSL250-080F	Telcordia GR-1089 Intrabuilding – Surge 1 & 2	Telcordia GR-1089 Intrabuilding – 120V _{AC} , 25A ITU K.20/21/45 – 230V _{AC} , 10Ω	
TRF600	TRF600-150	TIA-968-A (formerly FCC Part 68)	UL60950, 3rd Ed. – 600V _{AC} , 40A	
	TRF600-160	Telcordia GR-1089 – Level 1 and 2, issue 2‡	Telcordia GR-1089 – 600V _{AC} , 60A	
TS600	TS600-170F	TIA-968-A (formerly FCC Part 68)	UL60950, 3rd Ed. – 600V _{AC} , 40A	
	TS600-200F-RA	Telcordia GR-1089 – Level 1 and 2, issue 2‡	Telcordia GR-1089 – 600V _{AC} , 60A	
TSM600	TSM600-250F	TIA-968-A (formerly FCC Part 68)	UL60950, 3rd Ed. – 600V _{AC} , 40A	
	TSM600-250F-RA	Telcordia GR-1089 – Level 1 and 2, issue 2‡	Telcordia GR-1089 – 600V _{AC} , 60A	
	TSM600-400F	TIA-968-A (formerly FCC Part 68) Telcordia GR-1089, issue 3	UL60950, 3rd Ed. – 600V _{AC} , 40A Telcordia GR-1089 – 600V _{AC} , 60A	
FT600**	FT600-0500	TIA-968-A - Type A & B	UL60950, 600V _{AC} , 40A	
	FT600-1250	TIA-968-A - Type A & B	UL60950, 3rd Ed. – 600V _{AC} , 40A	
	FT600-2000		Telcordia GR-1089 – 600V _{AC} , 60A	

* Applies to all products which share the same prefix.

† Tested with 230V gas discharge tube primary protector.

‡ May require additional series resistor to help telecommunication equipment pass Surge 3 (1kV, 10/1000µs).

** See FT600 section on page 100.

Table T1 Product Series: Size, Current Rating, Voltage Rating, Typical Resistance for Telecommunications and Networking Devices

	TCF250	TRF250	TS250	TSV250	TSL250	TS600 TSM600	TRF600
Voltage Rating (V)† (Operating/Interrupt)	60/250	60/250	60/250	60/250	80/250	60/600	60/600
Specification	ITU	ITU	ITU	ITU	Telcordia GR-1089 Intrabuilding	UL60950 Telcordia GR-1089	UL60950 Telcordia GR-1089
Hold Current (A)							
0.080	—	17.0Ω	—	—	8.0Ω	—	—
0.100	—	—	—	—	—	—	—
0.110	—	7.0Ω	—	—	—	—	—
0.120	10.5Ω	6.0-9.5Ω	—	—	—	—	—
0.130	—	—	8.0-10.5Ω	5.5Ω	—	—	—
0.140	—	—	—	—	—	—	—
0.145	7.0Ω	4.3-5.0Ω	—	—	—	—	—
0.150	—	—	—	—	—	—	8.0Ω
0.160	—	—	—	—	—	—	5.5-7.0Ω*
0.170	—	—	—	—	—	11.0Ω	—
0.180	1.4Ω	1.5Ω‡	—	—	—	—	—
0.183	—	0.8-2.0Ω‡	—	—	—	—	—
0.200	—	—	—	—	—	8.5Ω	—
0.250	—	—	—	—	—	3.0-3.5Ω*	—
0.300	—	—	—	—	—	—	—
0.400	—	—	—	—	—	1.1Ω	—
0.550	—	—	—	—	—	—	—
0.750	—	—	—	—	—	—	—

* These devices have a maximum operating voltage of 250V

† Voltage Rating for telecommunications and networking devices is dependent upon the nature of the fault conditions. See telecom fuses section on page 100.

‡ These devices have a maximum operating voltage of 100V

Voltage Ratings for Telecommunications and Networking Devices

For Raychem Circuit Protection telecommunications devices (TCF, TRF, TSx series) there are two applicable voltage ratings. These are **V_{Max} Operating** and **V_{Max} Interrupt**. To help understand the nature of these two different voltage ratings, the following definitions are provided:

V_{Max} Operating : For telecommunications devices this is the voltage we have used to obtain component recognition under UL1434. Most Raychem Circuit Protection devices (TCF, TRF, TSx) are certified at 60V but can withstand higher V_{max}. TRF600-160 and TSM600 product families are certified at 250V but can withstand higher V_{Max}. Interrupt conditions as noted above.

V_{Max} Interrupt : Under specified conditions this is the highest voltage that can be applied to the device at the maximum current. Devices have been designed to trip safely under higher power level cross conditions, as listed above, to assist equipment in meeting the appropriate industry conditions.

Table T2 Thermal Derating for Telecommunications and Networking Devices [Hold Current (A) at Ambient Temperature (°C)]

Part Number	Maximum Ambient Temperature								
	-40°C	-20°C	0°C	20°C	40°C	50°C	60°C	70°C	85°C
Chip* — 60/250V									
TCF250									
TCF250-120T	0.186	0.165	0.143	0.120	0.099	0.088	0.077	0.066	0.050
TCF250-145T	0.225	0.199	0.172	0.145	0.119	0.106	0.093	0.080	0.060
TCF250-180**	0.269	0.240	0.211	0.180	0.153	0.138	0.123	0.109	0.087
Radial-leaded* — 60/250V									
TRF250									
TRF250-080U	0.124	0.110	0.095	0.080	0.066	0.059	0.051	0.044	0.033
TRF250-110U	0.171	0.151	0.131	0.110	0.091	0.081	0.071	0.061	0.046
TRF250-120	0.186	0.165	0.143	0.120	0.099	0.088	0.077	0.066	0.050
TRF250-145	0.225	0.199	0.172	0.145	0.119	0.106	0.093	0.080	0.060
TRF250-180**	0.279	0.247	0.213	0.180	0.147	0.131	0.115	0.099	0.074
TRF250-180US**	0.279	0.247	0.213	0.180	0.147	0.131	0.115	0.099	0.074
NEW TRF250-183**	0.284	0.251	0.217	0.183	0.149	0.133	0.117	0.101	0.075
Surface† — 80/250V									
TSL250									
TSL250-080F	0.124	0.110	0.095	0.080	0.066	0.059	0.051	0.044	0.033
Surface* — 60/250V									
TS250/TSV250									
TS250-130F	0.208	0.182	0.156	0.130	0.104	0.091	0.078	0.065	0.045
TSV250-130F	0.208	0.182	0.156	0.130	0.104	0.091	0.078	0.065	0.045
Radial-leaded‡ — 60/600V									
TRF600									
TRF600-150	0.233	0.206	0.178	0.150	0.124	0.110	0.096	0.083	0.062
TRF600-160	0.249	0.219	0.190	0.160	0.132	0.117	0.103	0.088	0.066
Surface‡ — 60/600V									
TSM600/TSM600									
TSM600-170F	0.264	0.230	0.200	0.170	0.140	0.125	0.109	0.094	0.070
TSM600-200F-RA-B-0.5	0.310	0.275	0.238	0.200	0.165	0.147	0.128	0.110	0.083
TSM600-250F	0.400	0.350	0.300	0.250	0.198	0.170	0.140	0.117	0.083
TSM600-250F-RA	0.400	0.350	0.300	0.250	0.198	0.170	0.140	0.117	0.083
TSM600-400F	0.640	0.560	0.480	0.400	0.320	0.270	0.230	0.190	0.130

* 60/250V products are designed to help equipment pass ITU recommendations (K.20, K.21, etc) and Telcordia GR-1089 Intra-building power cross.

† 80/250V products are designed to help equipment pass Telcordia GR-1089 Intra-building power cross (120V_{AC}/25A).

‡ 60/600V products are designed to help equipment pass UL60950, TIA-968-A (formerly FCC Part 68) and GR1089 specifications.

** Product is not currently available in a resistance matched or sorted option.

Figure T1 Thermal Derating [Hold Current (A) at Ambient Temperature (°C)]

- A = TCF250-180
- B = All other TCF, TRF, TSx, TSM series devices

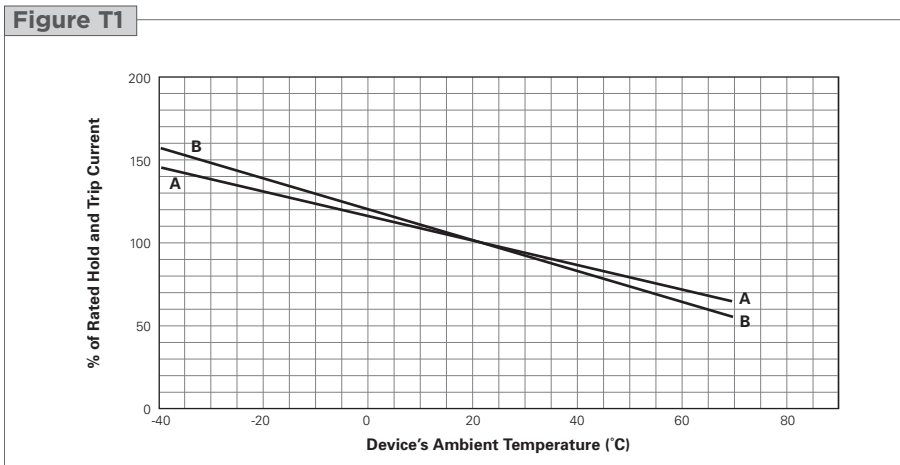


Table T3 Electrical Characteristics for Telecommunications and Networking Devices

Part Number	I _H (A)	I _T (A)	V _{Max} Operating (V _{DC})	V _{Max} Interrupt (V _{RMS})	I _{Max} (A)	P _D TYP (W)	Time-to-trip		R _{Min} (Ω)	R _{Max} (Ω)	R ₁ Max (Ω)
							(A)	(s)			
Chip* — 60/250V											
TCF250											
TCF250-120T	0.120	0.240	60	250	3.0	1.0	1.0	1.20 max	6.3	12.0	18.0
TCF250-145T	0.145	0.290	60	250	3.0	1.0	1.0	1.50 nom	5.0	9.0	14.0
TCF250-180**	0.180	0.650	60	250	3.0	0.8	1.0	15.50 nom	1.0	2.2	4.0
Radial-leaded* — 60/250V											
TRF250											
TRF250-080T	0.080	0.160	60	250	3.0	0.6	0.35	4.00 max	15.0	22.0	33.0
TRF250-080U	0.080	0.160	60	250	3.0	0.6	0.35	4.00 max	14.0	20.0	33.0
TRF250-110U	0.110	0.220	60	250	3.0	1.0	1.00	0.75 nom	5.0	9.0	16.0
TRF250-120	0.120	0.240	60	250	3.0	1.0	1.00	1.50 nom	4.0	8.0	16.0
TRF250-120T	0.120	0.240	60	250	3.0	1.0	0.35	0.70 nom	7.0	12.0	16.0
TRF250-120T-RA	0.120	0.240	60	250	3.0	1.0	1.00	1.20 nom	7.0	9.0	16.0
TRF250-120T-RC	0.130	0.260	60	250	3.0	1.0	1.00	3.00 nom	5.4	7.5	14.0
TRF250-120T-RF	0.120	0.240	60	250	3.0	1.0	1.00	0.90 nom	6.0	10.5	16.0
TRF250-120T-R1	0.120	0.240	60	250	3.0	1.0	1.00	1.00 nom	6.0	9.0	16.0
TRF250-120T-R2	0.120	0.240	60	250	3.0	1.0	1.00	0.75 nom	8.0	10.5	16.0
TRF250-120U	0.120	0.240	60	250	3.0	1.0	1.00	1.00 nom	6.0	10.0	16.0
TRF250-120UT	0.120	0.240	60	250	3.0	1.0	1.00	0.70 nom	7.0	12.0	16.0
TRF250-145	0.145	0.290	60	250	3.0	1.0	1.00	2.50 nom	3.0	6.0	14.0
TRF250-145-RA	0.145	0.290	60	250	3.0	1.0	1.00	2.50 nom	3.0	5.5	12.0
TRF250-145-RB	0.145	0.290	60	250	3.0	1.0	1.00	2.00 nom	4.5	6.0	14.0
TRF250-145T	0.145	0.290	60	250	3.0	1.0	1.00	1.50 nom	5.4	7.5	14.0
TRF250-145U	0.145	0.290	60	250	3.0	1.0	1.00	2.00 nom	3.5	6.5	14.0
TRF250-180**	0.180	0.650	100	250	10.0	1.5	3.00	0.50 nom	0.8	2.2	4.0
TRF250-180US**	0.180	0.650	100	250	10.0	1.4	3.00	0.50 nom/2.0 max	0.8	2.2	4.0
NEW TRF250-183**	0.183	0.685	100	250	10.0	0.9	3.00	0.55 nom/1.8 max	0.8	2.2	3.4
Surface† — 80/250V											
TSL250											
TSL250-080F	0.080	0.160	80	250	3.0	1.2	1.0	0.80 nom	5.0	11.0	20.0
Surface* — 60/250V											
TS250/TSV250											
TS250-130F	0.130	0.260	60	250	3.0	1.1	1.0	0.90 nom	6.5	12.0	20.0
	—	—	60	600	1.0	—	—	—	—	—	—
TS250-130F-RA	0.130	0.260	60	250	3.0	1.1	1.0	1.40 nom	6.5	9.0	15.0
	—	—	60	600	1.0	—	—	—	—	—	—
TS250-130F-RB	0.130	0.260	60	250	3.0	1.1	1.0	0.70 nom	9.0	12.0	20.0
	—	—	60	600	1.0	—	—	—	—	—	—
TS250-130F-RC	0.130	0.260	60	250	3.0	1.1	1.0	1.10 nom	7.0	10.0	17.0
	—	—	60	600	1.0	—	—	—	—	—	—
TSV250-130F	0.130	0.260	60	250	3.0	1.5	1.0	2.00 nom	4.0	7.0	12.0††
Radial-leaded‡ — 60/600V											
TRF600											
TRF600-150	0.150	0.300	250	600	3.0	1.0	1.0	1.40 nom	6.0	10.0	17.0
TRF600-150-RB	0.130	0.260	250	600	3.0	1.0	1.0	1.00 nom	9.0	12.0	22.0
TRF600-160	0.160	0.320	250	600	3.0	1.0	1.0	7.50 nom	4.0	10.0	18.0
TRF600-160-RA	0.160	0.320	250	600	3.0	1.0	1.0	9.50 nom	4.0	7.0	16.0
TRF600-160-R1	0.160	0.320	250	600	3.0	1.0	1.0	9.00 nom	4.0	8.0	17.0
Surface‡ — 60/600V											
TSM600/TSM600											
TS600-170F	0.170	0.400	60	600	3.0	2.5	1.0	10.00 nom	4.0	9.0	18.0
TS600-200F-RA-B-0.5	0.200	0.400	60	600	3.0	2.5	1.0	12.00 nom	4.0	7.5	13.5
TSM600-250F	0.250	0.860	250	600	3.0	2.0	3.0	0.80 nom	1.0	3.5	7.0
TSM600-250F-RA	0.250	0.860	250	600	3.0	2.0	3.0	1.00 nom	1.0	3.0	5.0
TSM600-400F	0.400	1.000	250	600	3.0	2.0	3.0	5.0 nom/14.0 max	0.5	1.5	2.0

Notes:

- I_H : Hold current: maximum current device will pass without interruption in 20°C still air.
- I_T : Trip current: minimum current that will switch the device from low resistance to high resistance in 20°C still air.
- V_{Max} Interrupt : Maximum voltage that can be safely placed across a device in its tripped state under specified fault conditions.
- I_{Max} : Maximum fault current device can withstand without damage at rated voltage.
- P_D : Power dissipated from device when in the tripped state in 20°C still air.
- R_{Min} : Maximum resistance of device as supplied at 20°C unless otherwise specified.
- R₁Max : Measured one hour post-trip or post-reflow at 20°C.

* 60/250V products are designed to help equipment pass ITU recommendations (K.20, K.21, etc) and Telcordia GR-1089 Intra-building power cross.

† 80/250V products are designed to help equipment pass Telcordia GR-1089 Intra-building power cross (120V_{AC}/25A).

‡ 60/600V products are designed to help equipment pass UL60950, TIA-968-A (formerly FCC Part 68) and GR1089 specifications.

** Product is not currently available in a resistance matched or sorted option.

†† R₁Max measured 1 hour post-trip, or 24 hours post-reflow at 20°C.

Figure T2-T12 Dimension Figures for Telecommunications and Networking Devices

Figure T2

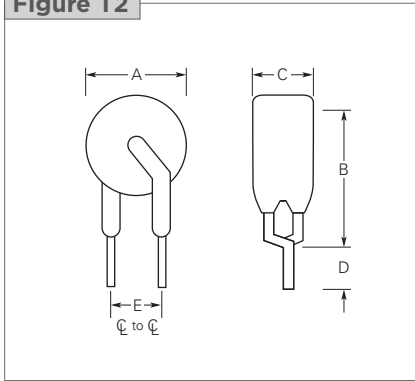


Figure T3

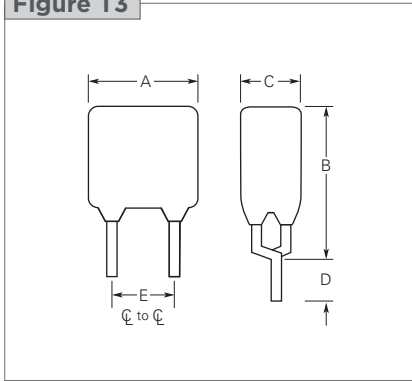


Figure T4

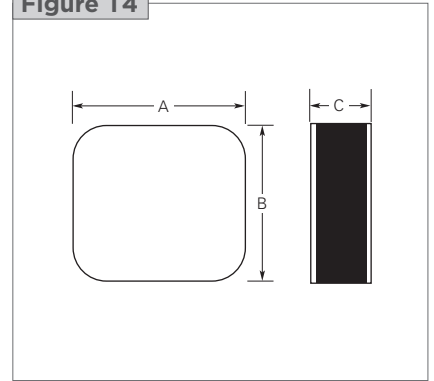


Figure T5

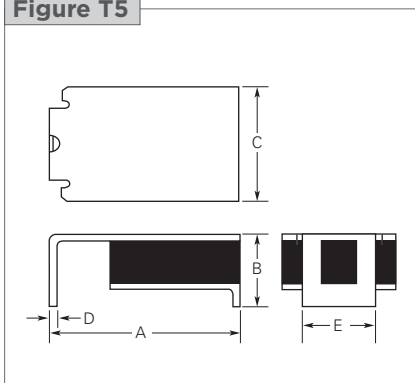


Figure T6

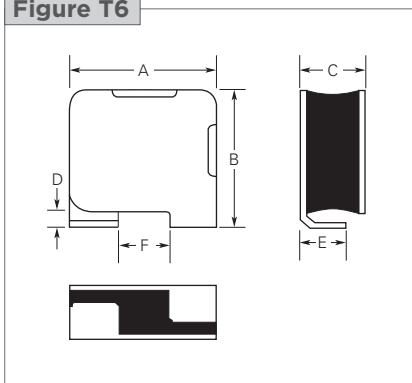


Figure T7

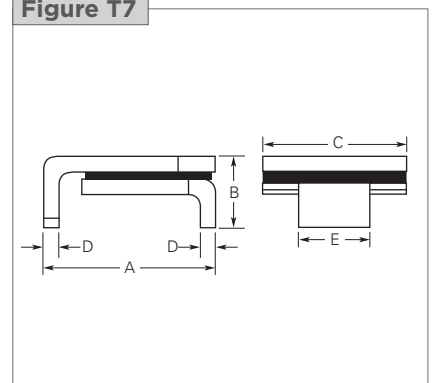


Figure T8

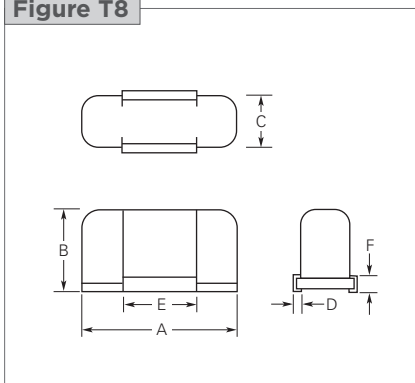


Figure T9

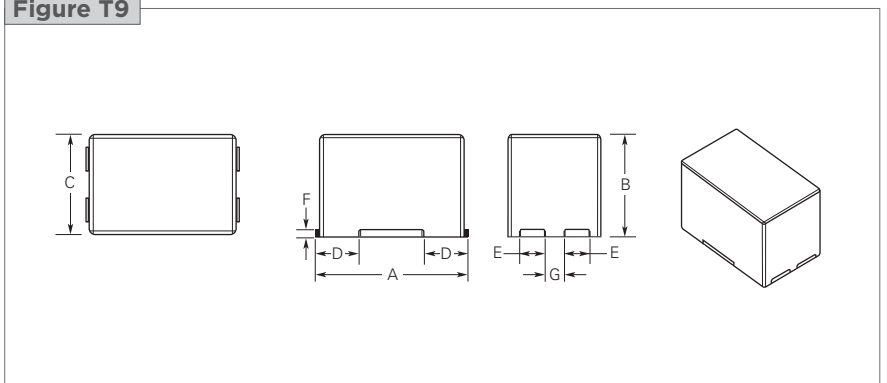


Figure T10

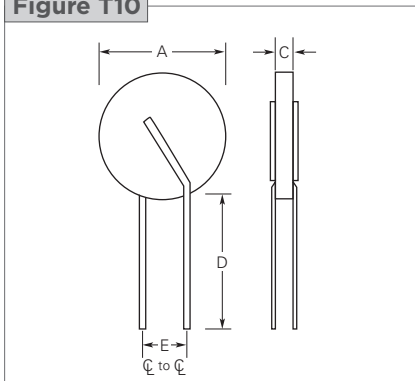


Figure T11

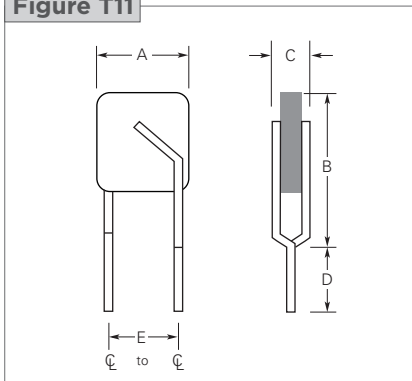


Figure T12

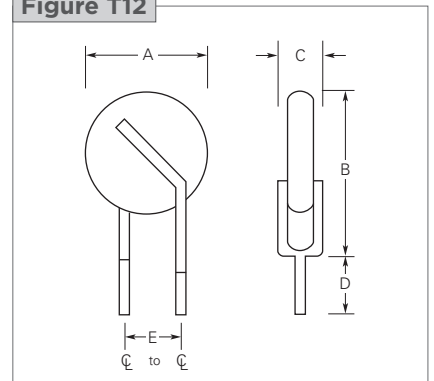


Table T4 Dimensions for Telecommunications and Networking Devices in Millimeters (Inches)

Part Number	A		B		C		D		E		F		G		Figure
	min	max	min	max	min	max	min	max	min	max	min	max	min	max	
TCF															
60/250V*															
TCF250-120T	5.4 (0.213)	5.6 (0.221)	5.4 (0.213)	5.6 (0.221)	2.0 (0.079)	2.3 (0.091)	—	—	—	—	—	—	—	—	T4
TCF250-145T	5.4 (0.213)	5.6 (0.221)	5.4 (0.213)	5.6 (0.221)	2.0 (0.080)	2.5 (0.100)	—	—	—	—	—	—	—	—	T4
TCF250-180	6.9 (0.270)	7.1 (0.280)	6.9 (0.270)	7.1 (0.280)	1.3 (0.050)	1.6 (0.060)	—	—	—	—	—	—	—	—	T4
TRF250															
60/250V*															
TRF250-080T	—	5.8 (0.228)	—	9.9 (0.390)	—	4.6 (0.181)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T2
TRF250-080U	—	4.8 (0.189)	—	9.3 (0.366)	—	3.8 (0.150)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T12
TRF250-110U	—	5.33 (0.210)	—	9.4 (0.370)	—	3.8 (0.150)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T12
TRF250-120	—	6.5 (0.256)	—	11.0 (0.433)	—	4.6 (0.181)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T3
TRF250-120U	—	6.0 (0.236)	—	10.0 (0.394)	—	3.8 (0.150)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T11
TRF250-145	—	6.5 (0.256)	—	11.0 (0.433)	—	4.6 (0.181)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T3
TRF250-145U	—	6.0 (0.236)	—	10.0 (0.394)	—	3.8 (0.150)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T11
TRF250-180	—	9.0 (0.354)	—	12.0 (0.412)	—	3.8 (0.150)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T2
TRF250-180US	—	8.1 (0.319)	—	—	—	3.0 (0.118)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T10
NEW TRF250-183	—	7.5 (0.290)	—	10.5 (0.410)	—	4.1 (0.160)	4.7 (0.185)	—	5.0** (0.197)	—	—	—	—	—	T2
TSL250															
80/250V†															
TSL250-080F	6.7 (0.265)	7.9 (0.310)	2.7 (0.110)	3.7 (0.145)	4.8 (0.190)	5.3 (0.210)	0.2 (0.008)	0.4 (0.015)	2.5 (0.100)	3.1 (0.120)	—	—	—	—	T7
TS250/TSV250															
60/250V*															
TS250-130F	8.5 (0.335)	9.4 (0.370)	—	3.4 (0.135)	—	7.4 (0.290)	0.3** (0.011)	—	3.8** (0.150)	—	—	—	—	—	T5
TSV250-130F	—	6.1 (0.240)	—	6.9 (0.270)	—	3.2 (0.126)	0.56 (0.022)	—	—	1.9 (0.075)	1.6 (0.065)	2.3 (0.091)	—	—	T6
TRF600															
60/600V‡															
TRF600-150	—	9.0 (0.354)	—	12.5 (0.492)	—	4.6 (0.180)	4.7 (0.185)	—	5.0 (0.197)	—	—	9.0 (0.354)	—	—	T3
TRF600-160	—	16.0 (0.630)	—	12.6 (0.496)	—	6.0 (0.236)	4.7 (0.185)	—	5.0** (0.197)	—	—	10.0 (0.394)	—	—	T3
TS600/TSM600															
60/600V‡															
TS600-170F	18.29 (0.720)	19.43 (0.765)	11.56 (0.455)	12.32 (0.485)	7.24 (0.285)	8.26 (0.325)	1.65 (0.065)	2.41 (0.095)	9.91 (0.390)	10.41 (0.410)	1.52 (0.060)	2.29 (0.090)	—	—	T8
TS600-200F-RA	18.29 (0.720)	19.43 (0.765)	11.56 (0.455)	12.32 (0.485)	7.24 (0.285)	8.26 (0.325)	1.65 (0.065)	2.41 (0.095)	9.91 (0.390)	10.41 (0.410)	1.52 (0.060)	2.29 (0.090)	—	—	T8
TSM600-250F	17.00 (0.671)	17.60 (0.690)	11.20 (0.440)	11.70 (0.460)	10.40 (0.410)	11.20 (0.440)	4.80 (0.187)	5.20 (0.203)	2.50 (0.099)	2.80 (0.111)	0.60 (0.022)	1.0 (0.038)	2.2 (0.087)	3.1 (0.122)	T9
TSM600-250F-RA	17.00 (0.671)	17.60 (0.690)	11.20 (0.440)	11.70 (0.460)	10.40 (0.410)	11.20 (0.440)	4.80 (0.187)	5.20 (0.203)	2.50 (0.099)	2.80 (0.111)	0.60 (0.022)	1.0 (0.038)	2.2 (0.087)	3.1 (0.122)	T9
TSM600-400F	17.00 (0.671)	17.60 (0.690)	11.20 (0.440)	11.70 (0.460)	10.40 (0.410)	11.20 (0.440)	4.80 (0.187)	5.20 (0.203)	2.50 (0.099)	2.80 (0.111)	0.60 (0.022)	1.0 (0.038)	2.2 (0.087)	3.1 (0.122)	T9

* 60/250V products are designed to help equipment pass ITU specifications (K.20, K.21, etc) and Telcordia GR-1089 Intrabuilding power cross.

† 80/250V product designed to help equipment pass Telcordia GR-1089 Intrabuilding power cross (120V_{ac}/25A).

‡ 60/600V products are designed to help equipment pass UL 60950, TIA-968-A (formerly FCC Part 68) and Telcordia GR-1089 specification.

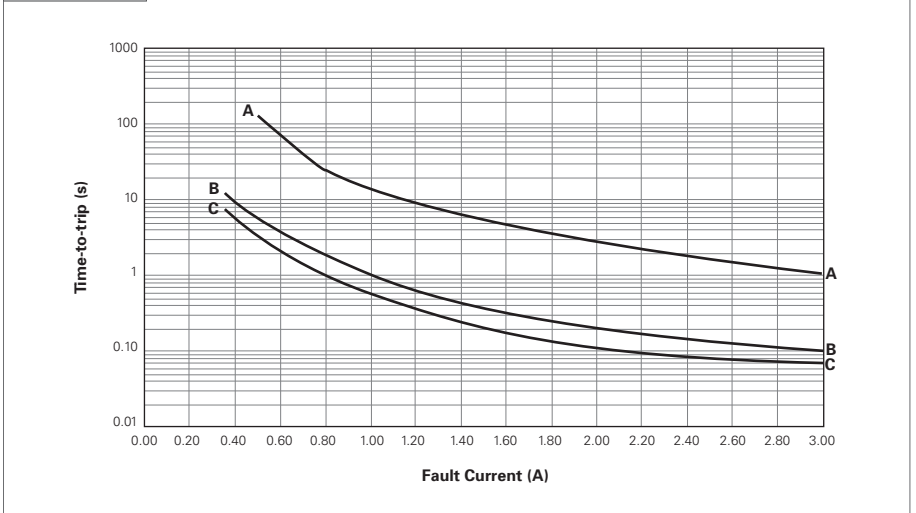
** Indicates dimension is typical, not minimum.

Figure T13-T16 Typical Time-to-trip Curves at 20°C for Telecommunications and Networking Devices

TCF250

- A = TCF250-180
- B = TCF250-145T
- C = TCF250-120T

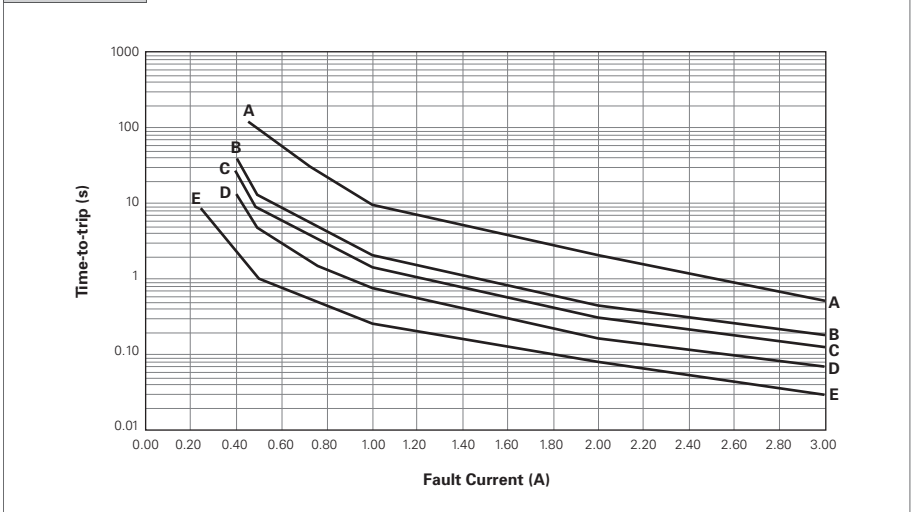
Figure T13



TRF250

- A = TRF250-180/183
- B = TRF250-145/145U
- C = TRF250-120/120U
- D = TRF250-110U/120UT/120T
- E = TRF250-080T/080U/080US

Figure T14



TS250/TSV250/TSL250

- A = TSV250-130F
- B = TS250-130F
- C = TSL250-080F

Figure T15

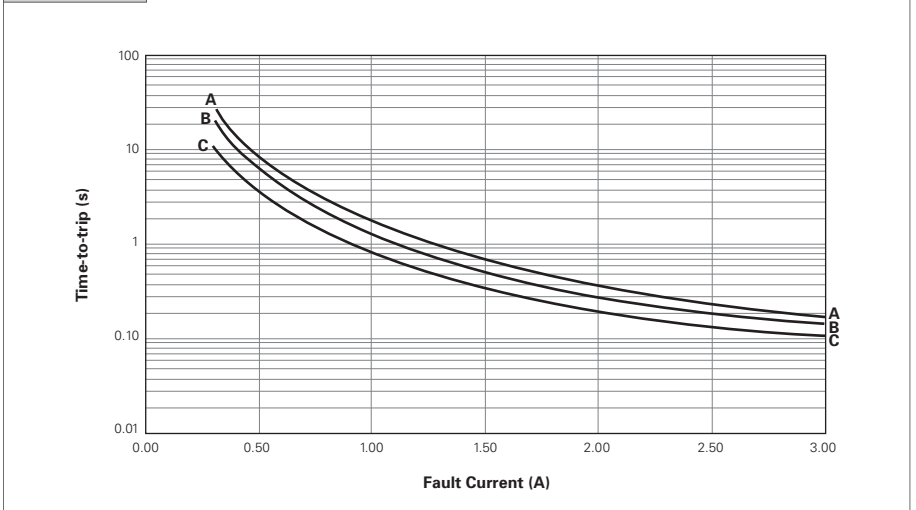


Figure T13-T16 Typical Time-to-trip Curves at 20°C for Telecommunications and Networking Devices ... Cont'd

TRF600/TS600/TSM600

- A = TSM600-250F
- B = TS600-170F/200F
- C = TRF600-160
- D = TRF600-150
- E = TSM600-400F

Figure T16

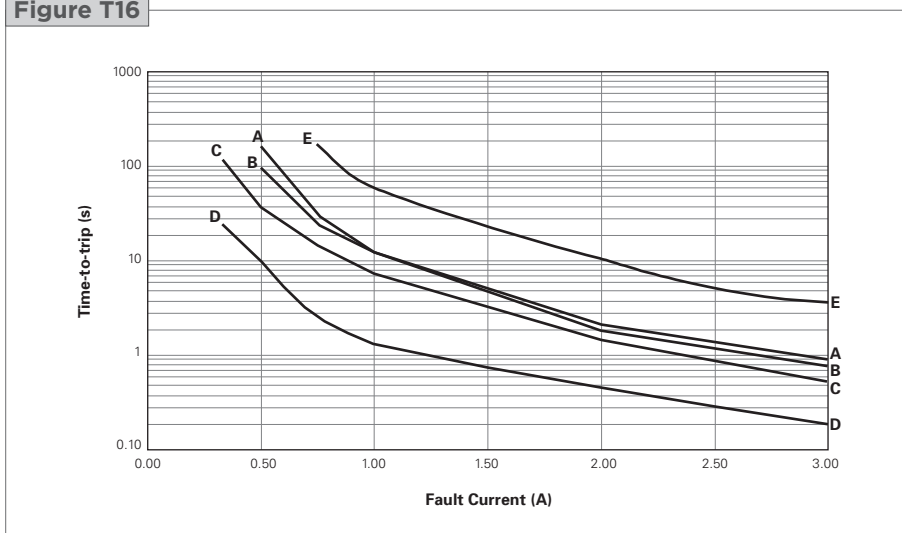


Table T5 Physical Characteristics and Environmental Specifications for Telecommunications and Networking Devices

(Operating temperature range for all listed products is -40°C to 85°C)

TCF250*
Physical Characteristics

Terminal material	Nickel foil
-------------------	-------------

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 1000 hours
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

TRF250*
Physical Characteristics

Lead material	Tin plated copper, 22AWG
Insulating material	Cured epoxy polymer
Flammability	per IEC 695-2-2 Needle Flame Test for 20s
Soldering characteristics	ANSI/J-STD-002, Category 3
Solder heat withstand	IEC-STD 68-2-20, Test Tb, Section 5 Method 1A, Condition B: can withstand 10 seconds at 260°C±5°C

Note: Devices are not designed to be placed through a reflow process.

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 1000 hours
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

(Operating temperature range for all listed products is -40°C to 85°C)

TS250*/TSV250*/TSL250†

Physical Characteristics

Terminal material	Tin plated brass, Nickel under plating
Soldering characteristics	EIC 60008-2-58

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 500 hours
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

TRF600‡

Physical Characteristics

Lead material	Tin plated copper, 22AWG
Insulating material	Cured epoxy polymer**
Flammability	per IEC 695-2-2 Needle flame test for 20s
Soldering characteristics	ANSI/J-STD-002, Category 3
Solder heat withstand	IEC-STD 68-2-20, Test Tb, Section 5 Method 1A, Condition B: can withstand 10 seconds at 260°C±5°C

Note: Devices are not designed to be placed through a reflow process. Contact Raychem Circuit Protection product representative for TR600 series devices that are compatible with this process.

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 1000 hours
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

TS600‡

Physical Characteristics

Terminal material	Tin-plated brass
Insulating material	Nylon resin (UL94V-0), 1000V dielectric rating
Flammability	IEC 695-2-2 Needle Flame Test for 20s
Soldering characteristics	ANSI/J-STD-002, Category 3
Solder heat withstand	IEC-STD 68-2-20, Test Tb, Section 5 Method 1A

Environmental Specifications

Test	Conditions
Passive aging	60°C, 1000 hours
	85°C, 1000 hours
Humidity aging	85°C, 85% RH, 1000 hours
Thermal shock	125°C, -55°C (10 times)
Solvent resistance	MIL-STD-202, Method 215F

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

Table T5 Physical Characteristics and Environmental Specifications for Telecommunications and Networking Devices

... Cont'd

(Operating temperature range for all listed products is -40°C to 85°C)

TSM600‡
Physical Characteristics

Terminal material	Tin-plated brass
Insulating material	Nylon resin (UL94V-0), 1000V dielectric rating
Flammability	IEC 695-2-2 Needle Flame Test for 20s
Soldering characteristics	ANSI/J-STD-002, Category 3
Solder heat withstand	IEC-STD 68-2-20, Test Tb, Section 5 Method 1A

Environmental Specifications

Test	Conditions
Lead material	Tin-plated brass
Case material	Nylon resin (UL94 V-0), 1000 V dielectric rating
Lead solderability	IEC 60068-2-58, Method 7
Solder heat withstand	IEC-STD 68-2-20, Test Tb, Section 5, Method 1A
Solvent resistance	MIL-STD-202, Method 215J
Flammability rating	IEC 695-2-2 Needle Flame Test for 20s
Storage humidity	Per IPC/JEDEC J-STD-020A Level 2a

Note: Storage conditions: 40°C max., 70% RH max., devices should remain in original sealed bag prior to use. Devices may not meet specified values if these storage conditions are exceeded.

* 60/250V products are designed to help equipment pass ITU recommendations (K.20, K.21, etc) and Telcordia GR-1089 Intrabuilding power cross.

† 80/250V product designed to help equipment pass Telcordia GR-1089 Intrabuilding power cross (120V_{AC}/25A).

‡ 60/600V products are designed to help equipment pass UL 60950, TIA-968-A (formerly FCC Part 68) and Telcordia GR-1089 specification.

** Excluding TRF600-150

Table T6 Packaging and Marking Information for Telecommunications and Networking Devices

Part Number	Bag Quantity	Tape & Reel Quantity	Standard Package Quantity	Part Marking	Agency Recognition
Chip* — 60/250V					
TCF250					
TCF250-120T	2,500	—	10,000	—	—
TCF250-145T	2,500	—	10,000	—	—
TCF250-180	2,500	—	10,000	—	UL
Radial-leaded* — 60/250V					
TRF250					
TRF250-080U	500	—	10,000	—	UL, CSA, TÜV
TRF250-080U-2	—	1,500	7,500	—	UL, CSA, TÜV
TRF250-080T	500	—	10,000	08F	UL, CSA, TÜV
TRF250-110U	500	—	10,000	—	UL, CSA, TÜV
TRF250-110U-2	—	1,500	7,500	—	UL, CSA, TÜV
TRF250-120	500	—	10,000	20F	UL, CSA, TÜV
TRF250-120-2	—	1,500	7,500	20F	UL, CSA, TÜV
TRF250-120T	500	—	10,000	20F	UL, CSA, TÜV
TRF250-120T-2	—	1,500	7,500	20F	UL, CSA, TÜV
TRF250-120U	500	—	10,000	20F	UL, CSA, TÜV
TRF250-120U-2	—	1,500	7,500	20F	UL, CSA, TÜV
TRF250-120UT	500	—	10,000	20F	UL, CSA, TÜV
TRF250-145	500	—	10,000	45F	UL, CSA, TÜV
TRF250-145-2	—	1,500	7,500	45F	UL, CSA, TÜV
TRF250-145-RA	500	—	10,000	45F	UL, CSA, TÜV
TRF250-145U	500	—	10,000	45F	UL, CSA, TÜV
TRF250-145U-2	—	1,500	7,500	45F	UL, CSA, TÜV
TRF250-180	500	—	10,000	80F	UL, CSA, TÜV
TRF250-180-2	—	1,500	7,500	80F	UL, CSA, TÜV
TRF250-180US	500	—	10,000	—	UL, CSA, TÜV
NEW TRF250-183	500	—	10,000	83F	UL, CSA, TÜV
NEW TRF250-183-2	—	1,500	7,500	83F	UL, CSA, TÜV

Table T6 Packaging and Marking Information for Telecommunications and Networking Devices ... Cont'd

Part Number	Bag Quantity	Tape & Reel Quantity	Standard Pack Quantity	Part Marking	Agency Recognition
Surface† — 80/250V					
TSL250					
TSL250-080F-2	—	1,500	7,500	T08	UL, CSA, TÜV
Surface* — 60/250V					
TS250/TSV250					
TS250-130F-2	—	1,500	7,500	T13	UL, CSA, TÜV
TSV250-130F-2	—	1,200	6,000	T13V	UL, CSA, TÜV
Radial-leaded‡ — 60/600V					
TRF600					
TRF600-150	500	—	10,000	150F	UL, CSA, TÜV
TRF600-150-2	—	1,500	7,500	150F	UL, CSA, TÜV
TRF600-160	500	—	10,000	160F	UL, CSA, TÜV
TRF600-160-2	—	600	3,000	160F	UL, CSA, TÜV
Surface‡ — 60/600V					
TS600/TSM600					
TS600-170F-2	—	300	900	T20	UL, CSA
TS600-200F-RA-2	—	300	900	T20	UL, CSA
TSM600-250F-2	—	200	1,000	TSM600	UL, CSA
TSM600-250F-RA-2	—	200	1,000	TSM600	UL, CSA
TSM600-400F-2	—	200	1,000	TSM600	UL

* 60/250V products are designed to help equipment pass ITU recommendations (K.20, K.21, etc) and Telcordia GR-1089 Intra-building power cross.

† 80/250V product designed to help equipment pass Telcordia GR-1089 Intra-building power cross (120V_{AC}/25A).

‡ 60/600V products are designed to help equipment pass UL 60950, TIA-968-A (formerly FCC Part 68) and Telcordia GR-1089 specifications.

Agency Recognition for Telecommunications and Networking Devices

UL	File # E74889	
CSA	File #78165C	
TÜV	Per IEC60730-1	Certificate # for individual products available upon request.

Table T7 Recommended Pad Layouts for Surface-mount Telecommunications and Networking Devices in millimeters (inches) Nominal

Device	A	B	C	D	E	F	G	Figure
TS250 (All)	4.60 (0.180)	1.80 (0.070)	6.10 (0.240)	—	—	—	—	T17
TSV250-130F	2.29 (0.090)	2.41 (0.095)	6.35 (0.250)	3.43 (0.135)	—	—	—	T18
TSL250-080F	3.60 (0.140)	1.80 (0.070)	5.50 (0.220)	—	—	—	—	T17
TS600 (All)	10.42 (0.410)	3.30 (0.130)	3.35 (0.132)	—	—	—	—	T17
TSM600	5.20 (0.205)	17.80 (0.701)	5.54 (0.218)	6.75 (0.266)	2.08 (0.082)	3.12 (0.123)	8.39 (0.331)	T19

Figure T17

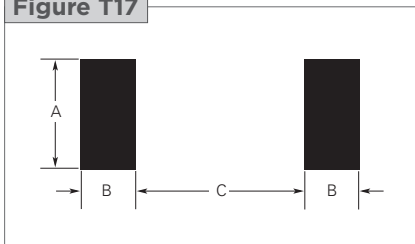


Figure T18

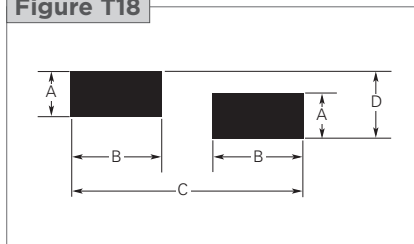
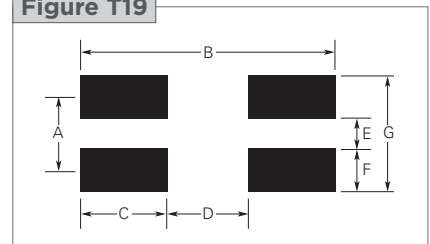


Figure T19



14

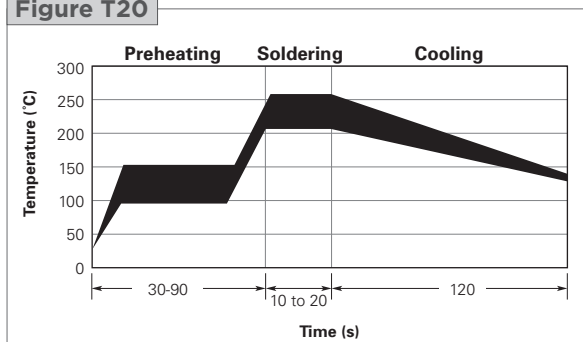
Solder Reflow and Rework Recommendations for Telecommunications Surface-mount Devices

Solder Reflow

- Recommended reflow methods: IR, vapor phase oven, hot air oven.
- Surface-mount devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness of 0.25mm (0.010 in).
- Devices can be cleaned using standard industry methods and solvents.

Rework

- If a device is removed from the board, it should be discarded and replaced with a new device.

Figure T20


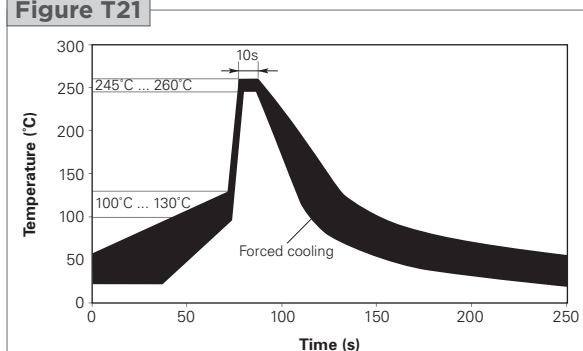
Wave Soldering and Rework Recommendations for Telecommunications Radial-leaded Devices

Recommended Wave Soldering

- Soldering temperature profile
Temperature characteristic at component terminal with dual wave soldering

Rework

- If a device is removed from the board, it should be discarded and replaced with a new device.

Figure T21

Table T8 TRF250/TRF600 Tape and Reel Specifications for Telecommunications and Networking Device

TRF250/TRF600 devices are available in tape and reel packaging per EIA 468-B standard. See Figures T22 and T23 for details.

Dimension Description	EIA Mark	IEC Mark	Dimension (mm)	Tolerance
Carrier tape width	W	W	18	-0.5/+1.0
Hold down tape width	W ₄	W ₀	5	Minimum
Top distance between tape edges	W ₆	W ₂	3	Maximum
Sprocket hole position	W ₅	W ₁	9	-0.5/+0.75
Sprocket hole diameter	D ₀	D ₀	4	±0.2
Abcissa to plane (straight lead)	H	H	18.5	±3.0
Abcissa to plane (kinked lead)*	H ₀	H ₀	16	-0.5/+0.6
Abcissa to top	H ₁	H ₁	32.2	Maximum
Overall width w/lead protrusion	—	C ₁	43.2	Maximum
Overall width w/o lead protrusion	—	C ₂	42.5	Maximum
Lead protrusion	L ₁	I ₁	1.0	Maximum
Protrusion of cut-out	L	L	11	Maximum
Protrusion beyond hold down tape	I ₂	I ₂	Not specified	—
Sprocket hole pitch	P ₀	P ₀	12.7	±0.3
Device pitch: TRF250	—	—	12.7	—
Device pitch: TRF600	—	—	25.4	—
Pitch tolerance	—	—	20 consecutive	±1
Tape thickness	t	t	0.9	Maximum
Tape thickness with splice*	t ₁	—	2.0	Maximum
Splice sprocket hole alignment	—	—	0	±0.3
Body lateral deviation	Δh	Δh	0	±1.0
Body tape plane deviation	Δp	Δp	0	±1.3
Lead spacing plane deviation	ΔP ₁	P ₁	0	±0.7
Lead spacing*	F	F	5.08	±0.6

Table T8 TRF250/TRF600 Tape and Reel Specifications for Telecommunications and Networking Device

... Cont'd

TRF250/TRF600 devices are available in tape and reel packaging per EIA 468-B standard. See Figures T22 and T23 for details.

Dimension Description	EIA Mark	IEC Mark	Dimension (mm)	Tolerance
Reel width	w_2	w	56	Maximum
Reel diameter	a	d	370	Maximum
Space between flanges less device	w_1	—	4.75	± 3.25
Arbor hole diameter	c	f	26	± 12.0
Core diameter	n	h	80	Maximum
Box	—	—	56/372/372	Maximum
Consecutive missing pieces*	—	—	3 maximum	—
Empty places per reel*	—	—	Not specified	—

* Differs from EIA specification.

Figure T22 EIA Referenced Taped Component Dimensions for TRF Devices

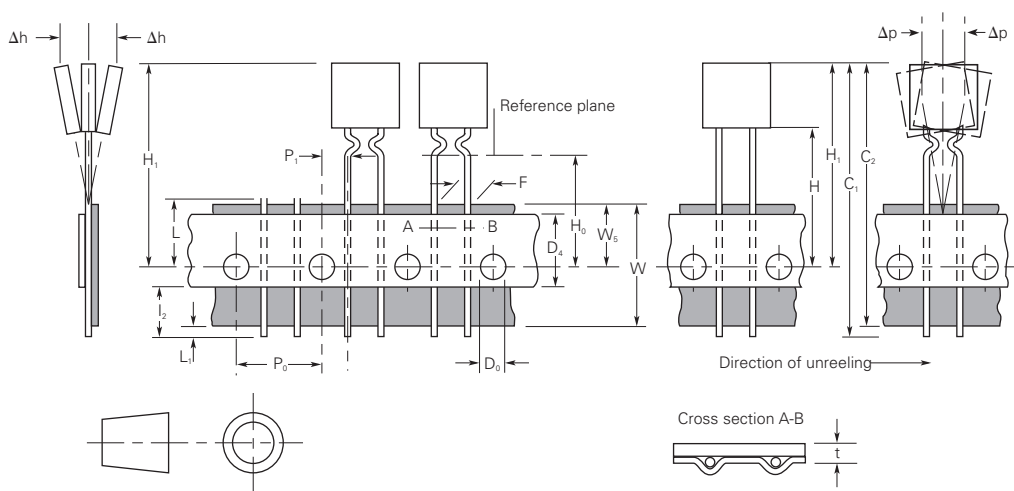
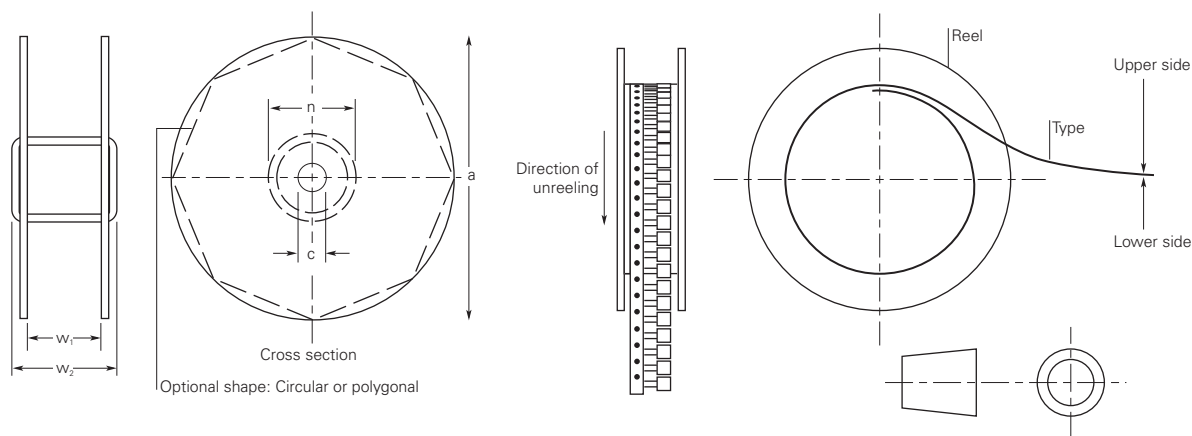


Figure T23 Reel Dimensions for TRF Devices



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Table T9 TS Tape and Reel Specifications for Telecommunications and Networking Devices

TS devices are packaged per EIA 481 and EIA 481-2 standards. See Figures T24 and T25 for details.

TS250/TSL250/TSV250							
Dimension Description	EIA Mark	TS250		TSV250		TSL250	
		Dimension(mm)	Tolerance(mm)	Dimension(mm)	Tolerance(mm)	Dimension(mm)	Tolerance(mm)
Carrier tape width	W	16	±0.30	16.0	±0.3	16	±0.3
Sprocket hole pitch	P ₀	4.0	±0.10	4.0	±0.1	4.0	±0.10
	P ₁	12.0	±0.10	8.0	±0.1	8.0	±0.10
	P ₂	2.0	±0.10	2.0	±0.1	2.0	±0.10
	A ₀	6.9	±0.23	5.5	±0.1	5.5	±0.10
	B ₀	9.6	±0.15	6.2	±0.1	7.9	±0.10
	B _{1 MAX.}	12.1	—	8.0	—	9.2	—
Sprocket hole diameter	D ₀	1.5	-0/+0.1	1.55	±0.05	1.55	±0.05
	F	7.5	±0.10	7.5	±0.10	7.5	±0.10
	E ₁	1.75	±0.10	1.75	±0.10	1.75	±0.10
	E _{2 MIN.}	14.25	—	—	—	—	—
Tape thickness	T _{MAX.}	0.4	—	0.45	—	0.35	—
Tape thickness with splice cover tape thickness	T _{1 MAX.}	0.1	—	0.1	—	0.1	—
Reel dimensions	K ₀	3.4	±0.15	7.0	±0.1	3.70	±0.10
	Leader min.	300	—	390	—	390	—
	Trailer min.	300	—	160	—	160	—
Reel diameter	A max.	340	—	340	—	340	—
Core diameter	N min.	50	—	50	—	50	—
Space between flanges less device	W ₁	16.4	-0/+2.0	16.4	-0/+2.0	16.4	-0/+2.0
Reel width	W _{2 MAX.}	22.4	—	22.4	—	22.4	—

TS600			
Dimension Description	EIA Mark	Dimension (mm)	Tolerance
Carrier tape width	W	32	±0.3
Sprocket hole pitch	P ₀	4.0	±0.1
	P ₁	16	±0.1
	P ₂	2.0	±0.1
	A ₀	10	±0.1
	B ₀	19.2	±0.1
	B _{1 max.}	21.6	—
Sprocket hole diameter	D ₀	1.5	-0/+1.0
	F	14.2	±0.1
	E ₁	1.75	±0.1
	E _{2 min.}	28.4	±0.1
Tape thickness	T _{max.}	0.50	±0.5
Tape thickness with splice	T _{1 max.}	0.1	—
Reel Dimensions	K ₀	13.2	±0.1
	Leader min.	390	—
	Trailer min.	160	—
Reel diameter	A max.	360	—
Core diameter	N min.	50	—
Space between flanges less device	W ₁	32.4	-0/+2.0
Reel width	W _{2 max.}	40	—

TSM600

Dimension Description	EIA Mark	Dimension (mm)	Tolerance
Carrier tape width	W	32	±0.3
Sprocket hole pitch	P ₀	4.0	±0.1
	P ₁	24	±0.1
	P ₂	2.0	±0.1
	A ₀	11.2	±0.1
	B ₀	17.8	±0.1
	B _{1 max.}	23.45	
Sprocket hole diameter	D	1.5	-0/+1.0
	F	14.2	±0.1
	E ₁	1.74	±0.1
	E _{2 min.}	28.4	±0.1
Tape thickness	T max.	0.5	±0.5
Tape thickness with splice	T _{1 max.}	0.1	
	K ₀	11.9	±0.1
	Leader min.	390	
	Trailer min.	160	
Reel Dimensions			
Reel diameter	A max.	360	
Core diameter	N min.	50	
Space between flanges less device	W ₁	32.4	-0/+2.0
Reel width	W _{2 max.}	40	

Figure T24 EIA Referenced Taped Component Dimensions for TS Devices

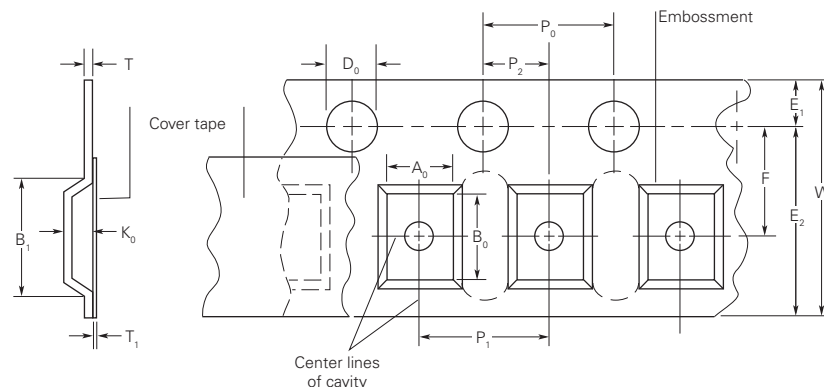
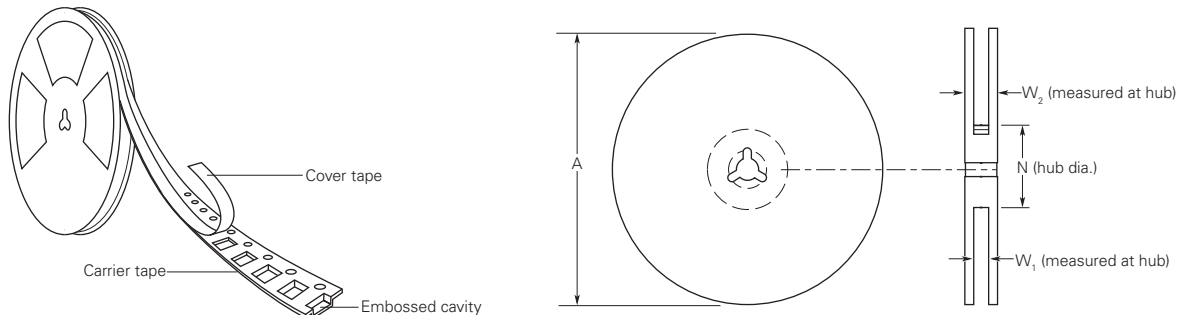


Figure T25 EIA Referenced Reel Dimensions for TS Devices



Resistance-sorted and Resistance-matched Devices

Most TCF, TRF and TS devices are available in resistance-sorted and/or resistance-matched versions.

Resistance-sorted Devices

Resistance-sorted devices (part number suffix “Rx”, where x = 1, 2, A, B, C, F etc.) are supplied with resistance values that are within specified segments of the device’s full range of resistance.

Feature

- Narrow resistance range.

Benefits

- Greater flexibility for design engineers.
- Lower resistance devices can allow for increased loop length on line card designs.
- Higher resistance devices may provide greater protection by offering faster time-to-trip.

Resistance-matched Devices

Resistance-matched devices are supplied such that all parts in one particular package (or reel) are within 0.5Ω of each other (1.0Ω for TRF250-080T devices). Individual matched packages are supplied from the full resistance range of the specified device.

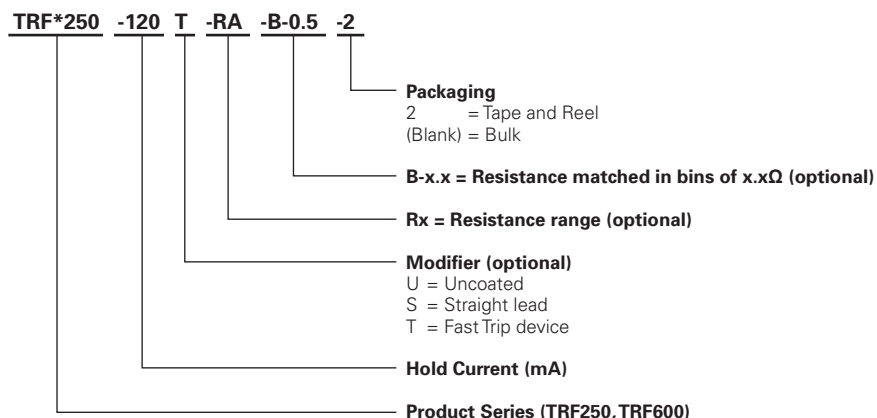
Feature

- Tighter resistance balance between any two parts in a package.

Benefits

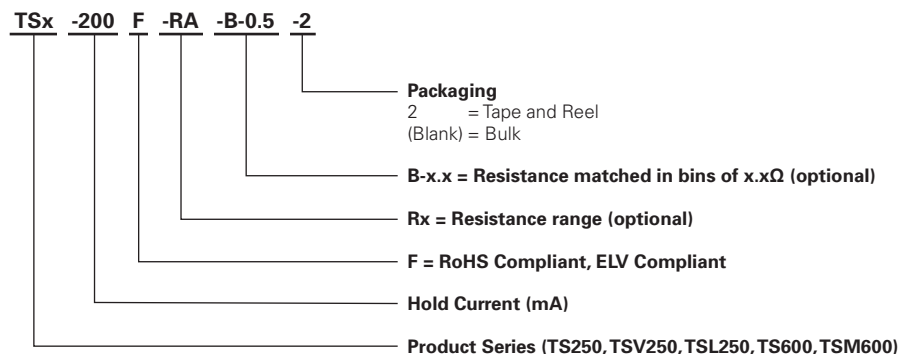
- Resistance-matched devices may reduce the tip-ring resistance differential, reducing the possibility of line imbalance.

Part Numbering System for Radial-led Telecommunications and Networking Devices

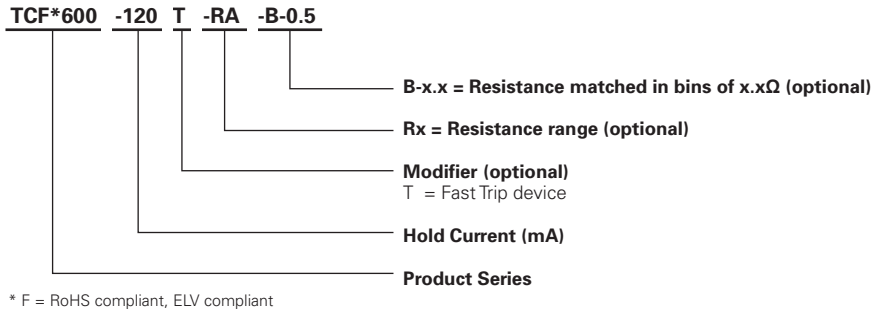


* F = RoHS compliant, ELV compliant

Part Numbering System for Surface-mount Telecommunications and Networking Devices



Part Numbering System for Chip Telecommunications and Networking Devices



Warning :

- Operation beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- The devices are intended for protection against occasional overcurrent or overtemperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- Operation in circuit with a large inductance can generate a circuit voltage ($L di/dt$) above the rated voltage of the PolySwitch resettable device.